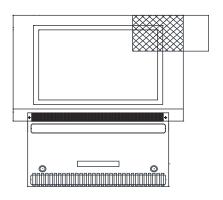


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COMPLIANT

96 x 64 Graphic OLED



FEA I	UKE2

Type: graphic

• Display format: 96 x 64 dots • Built-in controller: OLED-0010

• Duty cycle: 1/64 • +3 V power supply • Interface: SSD1305

Sunlight readable and polarizer optional

Material categorization: for definitions of compliance

please see www.vishav.com/doc?99912

MECHANICAL DATA						
ITEM	STANDARD VALUE	UNIT				
Module dimension	33.59 x 23.62 x 1.65					
Viewing area	25.49 x 17.65					
Active area	23.49 x 15.65	mm				
Dot size	0.215 x 0.215	111111				
Dot pitch	0.245 x 0.245					
Mounting hole	n/a					

ABSOLUTE MAXIMUM RATINGS									
ITEM	SYMBOL	STANDAF	LINUT						
IIEM	SYMBOL	MIN.	MAX.	UNIT					
Supply voltage for logic ⁽¹⁾⁽²⁾	V_{DD}	-0.3	4	V					
Supply voltage for display (1)(2)	V _{CC}	0	15	٧					
Operating temperature	T _{OP}	-40	+80	°C					
Storage temperature	T _{STG}	-40	+80	O					

Notes

- $^{(1)}$ All the above voltages are on the basis of "V_{SS} = 0 V".
- $\ensuremath{^{(2)}}$ When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to section 6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur, and the reliability of the module may deteriorate.

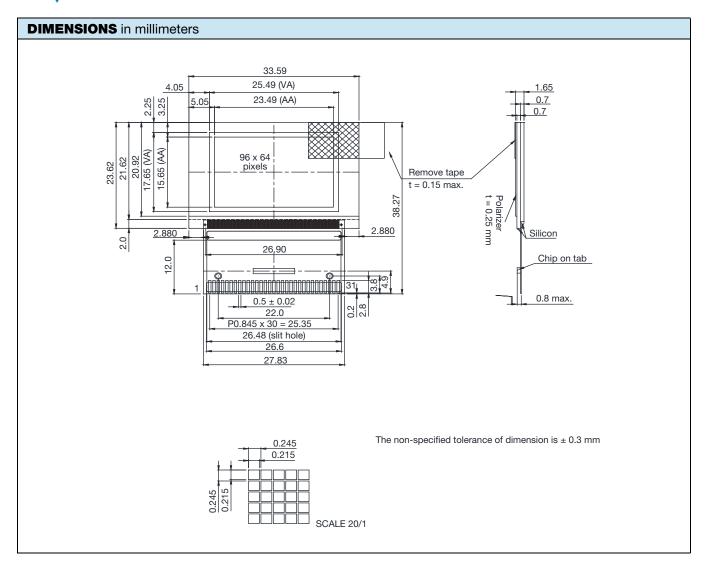
ELECTRICAL CHARACTERISTICS									
ITEM	SYMBOL	CONDITION	ST	ANDARD VAL	.UE	UNIT			
ITEM	STWIBOL CC	CONDITION	MIN.	TYP.	MAX.	UNIT			
Supply voltage for logic	V_{DD}	-	2.8	3.0	3.3				
Supply voltage for display	V _{CC}	-	10	12	15				
Input high voltage	V _{IH}	-	0.8 V _{DD}	-	V_{DD}	V			
Input low voltage	V_{IL}	-	0	-	0.2 V _{DD}	\ \ \			
Output high voltage	V _{OH}	-	0.9 V _{DD}	-	V_{DD}				
Output low voltage	V _{OL}	-	0	-	0.1 V _{DD}				
50 % check board operating current		V _{CC} = 12 V	7	8	10	mA			

OPTIONS	S								
	EM	ITTING COLO	OR				MOQ		
YELLOW	GREEN	RED	BLUE	WHITE	YELLOW	GREEN	RED	BLUE	WHITE
Yes	-	-	-	-	Yes	-	=	=	-

Revision: 11-Aug-16 Document Number: 37838



PIN NO.	SYMBOL			FUNCTION		
1	NC	No connection				
2	V _{CC}	Power supply for	analog circuit			
3	VCOMH		tput. A capacitor shou	ıld be connected be	tween this pin a	nd V _{SS}
4	IREF	Reference currer a resistor should	nt input pin be connected betwee	en this pin and V _{SS}		
5 to 12	D7 to D0	Data bus				
13	E/RD#	Data read operat	ion is initiated when i	t is pull low		
14	R/W#	Data read operat	ion is initiated when i	t is pull low		
15	D / C#		control e / read display data command or read sta	atus		
16	RES#	Reset signal inpu When it is low, in	ıt itialization of SSD130	5 is executed		
17	CS#	Chip select input				
18	FR	frame display tim	RAM write synchron ning can be achieved NC if it is not used. F	to prevent tearing et	fect.	en MCU data writing an usage.
19	BS2	Communicating These pins are N	protocol select ICU interface selectio	n input. See the follo	owing table:	
			68XX-parallel	80XX-parallel	Serial	I ² C
20	BS1	BS1	0	1	0	1
		BS2	1	1	0	0
21	V _{DDI/O}		r interface logic level. equal or lower than V _E		with MCU inter	rface voltage level. V _{DDI}
22	V_{DD}	Power supply for	logic circuit			
23	VCIR	This is a reserve	d pin. It should be kep	ot NC		
24	BGGND	This pin must be	connected to ground			
25	VBREF	This is a reserve	d pin. It should be kep	ot NC		
26	NC	No connection				
27	FB	This is a reserve	d pin. It should be kep	ot NC		
28	VDDB	This is a reserved	d pin. It must be conn	ected to V _{DD}		
29	GDR	This is a reserve	d pin. It should be kep	ot NC		
30	V _{SS}	Ground				
31	NC	No connection				





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1. Module Classification Information

OLED 096 Y 064 A L P P 3 N 0 0 000

	U	Ø	ၜ	4	9	<u> </u>	ω	ၜ	9	(II)	(II)	(12)	10)
1	Brand:	Vishay	Interted	hnol	ogy, Inc.								
2	Horizor	ntal Form	nat: 96 C	olum	ins								
3	Display Type: N→Character Type, H→Graphic Type, Y→Tab Type, O→Cog Type									уре			
4	Vertica	l Format:	: 64 Line	s									
5		Serials	code										
					A:Amb	oer			R	: REI)		
6		Emitting	g Color		B : Blue)			W	: Wh	ite		
					G : Gre	en			L	: Yello)W		
7		Polarize	er		P : With	n Polar	izer; N	I: Witl	nout P	olariz	er		
8		Display	Mode		P : Pas	sive M	atrix ;	A: Ac	tive Ma	atrix			
9	Driver Voltage				3: 3.0 V; 5: 5.0V								
10		Touch Panel			N: Without touch panel; T: With touch panel								
11		Produc	ts type		0 : Stan 1. Sunl 2. Tran 3. Flex 4. OLE	ight Rosparer	eadab nt OLE LED	D (T					
12		Produ	ıct grade	es	Product 0 : Stan 2 : B-le 3 : C-le 4 : high 5 : Cus	grade dard(A vel vel class(tomer	s: \-level AA-le offerin) vel) gs					
13		Serial N	No.		Applicat	tion se	rial nu	mber	(000~2	ZZZ)			



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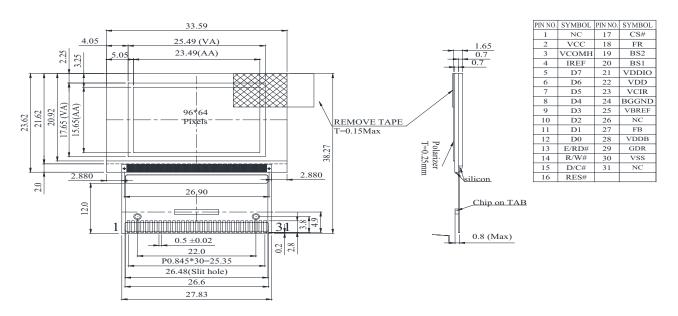
2.General Specification

Item	Dimension	Unit
Dot Matrix	96 x 64	_
Module dimension	33.59 × 23.62 × 1.65 (mm)	mm
Active Area	23.49 × 15.65 (mm)	mm
Pixel Size	0.215 × 0.215 (mm)	mm
Pixel Pitch	0.245 × 0.245 (mm)	mm
Display Mode	Passive Matrix	
Display Color	Monochrome (Yellow)	
Drive Duty	1/64 Duty	



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3. Contour Drawing & Block Diagram

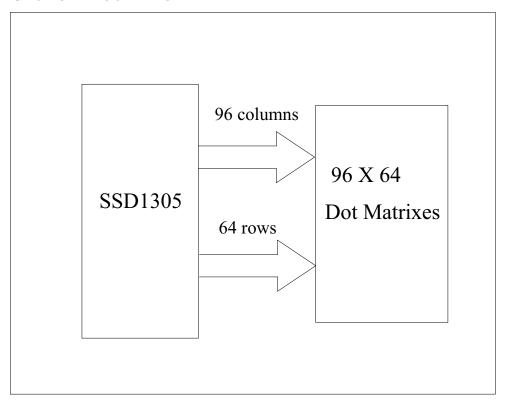


0.245

The non-specified tolerance of dimension is ± 0.3 mm.

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FUNCTION BLOCK DIAGRAM



^{*}For more information, please refer to Application Note provided by Vishay

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4. Interface Pin Function

No.	Symbol	Functio	n					
1	NC	No con	nection					
2	VCC	Powers	supply for analog	circuit.				
3	VCOMH			apacitor should be	e connect	ed		
3	VCOIVIN		between this pin and VSS.					
4	IREF		nce current input p					
	IKEF	A resist	or should be conr	nected between th	is pin and	l VSS.		
5~12	D7~D0	Data bu	IS.					
13	E/RD#	Data re	ad operation is in	itiated when it's ρι	ıll low.			
14	R/W#	Data wi	rite operation is in	itiated when it's p	ull low.			
			ommand control.					
15	D/C#		h for write/read di					
				nd or read status.				
16	RES#		ignal input.					
				n of SSD1305 is	executed.			
17	CS#		lect input.					
				ite synchronizatio			g	
			between MCU data writing and frame display timing can be					
18	FR		d to prevent teari		_			
				is not used. Pleas	e refer to	Section 8.4	for	
10		details		<u> </u>				
19	BS2		inicating Protocol					
			oins are MCU inte	rface selection in	out. See ti	ne tollowing	'	
20	DC4	table:	68XX-parallel	80XX-parallel	Serial	I2C	1	
20	BS1	BS1	0	1	0	1	•	
		BS2	1	1	0	0	1	
			•	<u> </u>	_	_		
21	VDDIO			DDIO must alway:				
41	VDDIO	VDD.	e voltage level. v	DDIO must aiway.	s be equa	ii oi iowei ti	iaii	
22	VDD		supply for logic cir	cuit				
23	VCIR			should be kept NC	:			
24	BGGND		must be connect		-			
25	VBREF			should be kept NC	2			
26	NC	No con		ss.a so noperte	<u> </u>			
27	FB			should be kent NO	<u> </u>			
28	VDDB		This is a reserved pin. It should be kept NC This is a reserved pin. It must be connected to VDD.					
29	GDR			should be kept NO				
30	VSS	Ground	•					
31	NC	No con						



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5.Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	VDD	-0.3	4	V	1, 2
Supply Voltage for Display	VCC	0	15	V	1, 2
Operating Temperature	TOP	-40	+80	°C	-
Storage Temperature	TSTG	-40	+80	°C	-

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate



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6.Electrical Characteristics

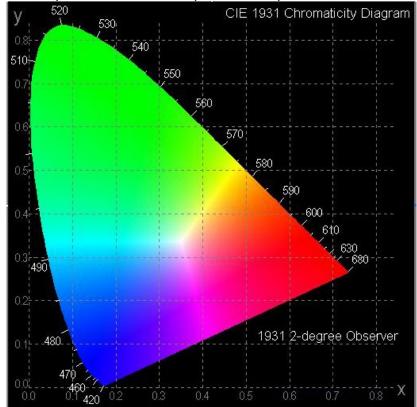
Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD	_	2.8	3.0	3.3	V
Supply Voltage for Display	VCC	_	10	12	15	V
High Level Input	VIH	_	0.8×VDD	_	VDD	V
Low Level Input	VIL	_	0	_	0.2×VDD	V
High Level Output	VOH	_	0.9×VDD	_	VDD	V
Low Level Output	VOL	_	0	_	0.1×VDD	V
50% Check Board operating Current	ng	VCC =12V	7	8	10	mA



7. Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	(V)θ		160			deg
View Aligie	(Η)φ		160			deg
Contrast Ratio	CR	Dark	2000:1		_	_
Response Time	T rise	_		10		μs
ixesponse fille	T fall	_		10		μs
Display with 50% check	Board Brig	ghtness	80	100		cd/m2
CIEx(Yellow)		(CIE1931)	0.45	0.47	0.49	
CIEy(Yellow)		(CIE1931)	0.48	0.50	0.52	

Notes: 1. Half-pixels-on is used as operation test pattern.





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8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°ℂ / Initial 50% check board brightness Typical Value	50,000 Hrs	_	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.



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9. Reliability

Content of Reliability Test

Environmenta Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80 °C 240hrs	
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40°C 240hrs	
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80 °C 240hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40 °C 240hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90% RH 240hrs	
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40 °C 25°C 30min 5min 30min 1 cycle	-40 °C/80°C 100 cycles	
Mechanical Te	st		
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hr	
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sin wave 11 ms 3 times of each direction	
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs	
Others			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact) ±800v(air), RS=330 Ω CS=150pF),

^{***} Supply voltage for OLED system =Operating voltage at 25°C

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Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

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10.Inspection specification

NO	Item	Criterion			AQL	
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 		0.65		
02	Black or white spots on OLED (display only)	 2.1 White and black spots on display ≦0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm. 		2.5		
03	OLED black spots, white spots, contamina tion (non-displ ay)	3.1 Round type : As following drawing Φ=(x+y)/2 X Y Y		SIZE $\Phi \le 0.10$ $0.10 < \\ \Phi \le 0.20$ $0.20 < \\ \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2	2.5
		3.2 Line type : (As follows: Lender L) L L L L L L	ogth V V 3.0 0 2.5 0	drawing) Vidth V≤0.02 .02 <w≤0.03 .03<w≤0.05="" .05<w<="" td=""><td>Acceptable Q TY Accept no dense 2 As round type</td><td>2.5</td></w≤0.03>	Acceptable Q TY Accept no dense 2 As round type	2.5
04	Polarizer bubbles	If bubbles are visible, judge using black spousing black spousing specifications, not eat to find, must check in specify direction.	ot d sy C	Size Φ D ≤ 0.20 0.20 < Φ ≤ 0.50 0.50 < Φ ≤ 1.00 0.00 < Φ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5



NO	Item	Criterion	AQL
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination	
			7.00.2
06	Chipped glass		2.5
6.1.2 Corner crack:		X X X X X X X X X X X X X X X X X X X	
		z: Chip thickness y: Chip width x: Chip length $Z \le 1/2t$ Not over viewing $x \le 1/8a$	
		Z ≥ 1/Zt	
		1/2t < z ≤ 2t Not exceed 1/3k x ≤ 1/8a	
		⊙ If there are 2 or more chips, x is the total length of each chip.	



NO	Item	Criterion	AQL
		Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:	
		y: Chip width x: Chip length z: Chip thickness	
		$\begin{array}{ c c c c c c c c c }\hline y \leq 0.5 \text{mm} & x \leq 1/8 \text{a} & 0 < z \leq t \\ \hline 6.2.2 \text{ Non-conductive portion:} & & & & \\ \hline \end{array}$	
06	Glass crack	y: Chip width x: Chip length z: Chip	2.5
		y. Griip widin X. Griip lerigin 2. Griip thickness	
		$y \le L$ $x \le 1/8a$ $0 < z \le t$	
must remain and be inspected according to el specifications. ⊙ If the product will be heat sealed by the custor mark not be damaged. 6.2.3 Substrate protuberance and internal crack y: width		 If the product will be heat sealed by the customer, the alignment mark not be damaged. 6.2.3 Substrate protuberance and internal crack. y: width x: length 	
		y All Property of the Property	





NO	Item	Criterion	AQL
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down. 	2.5 2.5 0.65 2.5 2.5 0.65 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65





NO	Item	Criterion	AQL
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65



Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Short	Major	
Wrong Display	Major	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	A Normal B Dark Pixel C Light Pixel

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11.Precautions in use of OLED Modules

Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3)Don't disassemble the OLED display module.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist OLED display module.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8)It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9)Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time..
- (10) Vishay has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11) Vishay have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Vishay have the right to modify the version.)

11.1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalent
 - Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent

such as ethyl alcohol, since the surface of the polarizer will become cloudy.

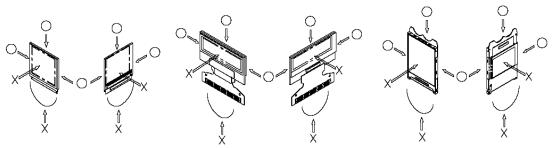
Also, pay attention that the following liquid and solvent may spoil the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts.

These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



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- (7) Do not apply stress to the LSI chips and the surrounding molded sections.
- (8) Do not disassemble nor modify the OLED display module.
- (9) Do not apply input signals while the logic power is off.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
- * Be sure to make human body grounding when handling OLED display modules.
- * Be sure to ground tools to use or assembly such as soldering irons.
- * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.
- (11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

11.2. Storage Precautions

(1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments.

(We recommend you to store these modules in the packaged state when they were shipped from Vishay.

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

(2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

11.3. Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- (5) As for EMI, take necessary measures on the equipment side basically.

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- (6) When fastening the OLED display module, fasten the external plastic housing section.
- (7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
- * Connection (contact) to any other potential than the above may lead to rupture of the IC.

11.4. Precautions when disposing of the OLED display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

11.5. Other Precautions

- (1) When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
- Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- (2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
- * Pins and electrodes
- * Pattern layouts such as the TCP & FPC
- (3) With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
- * Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
- * Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- (4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- (5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (6)Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.
- (7)Our company will has the right to upgrade and modify the product function.



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